



Product Change Notification

Change Notification #: 116353 - 00
Change Title: Intel® Compute Stick STK2m3W64CC,
 Intel® Compute Stick STK2m3W64CCL,
 PCN 116353-00, Product Design,
 Windows Image Update
Date of Publication: July 03, 2018

Key Characteristics of the Change:
 Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	July 13, 2018
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Description of Change to the Customer:

The Intel® Compute Stick SKUs listed in the products affected table below will have the following change.

- The Windows 10 Image is being updated to Redstone4.

Customer Impact of Change and Recommended Action:

This change has been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers.

Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Post Change SA
BOXSTK2M3W64CC	944712	H87908-212	H87908-213
BOXSTK2M3W64CCL	947055	H97102-208	H97102-209

PCN Revision History:

Date of Revision: July 3, 2018	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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